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April 1st, 2010
Renesas Electronics Corporation

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H8/300H Tiny Series

Buffer Operation of Timer Z Input Capture Function

Introduction

The buffer operation of the input-capture function supported by timer Z is used to measure the high-level width and low-level width of a pulse.

Target Device

H8/3687

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1. Specifications

1. As shown in figure 1.1, the buffer function of timer Z input-capture function is used to measure the high-level width and low-level width of a pulse input to the input-capture pin A0 (FTIOA0).
2. The timer counter 0 (TCNT0) measures the time from rising edge to falling edge of the pulse to measure the high-level width of the pulse.
3. The timer counter 0 (TCNT0) measures the time from falling edge to rising edge of the pulse to measure the low-level width of the pulse.
4. The maximum width of a pulse that can be measured is 32.768 ms with the accuracy of $\pm 0.5 \mu\text{s}$.

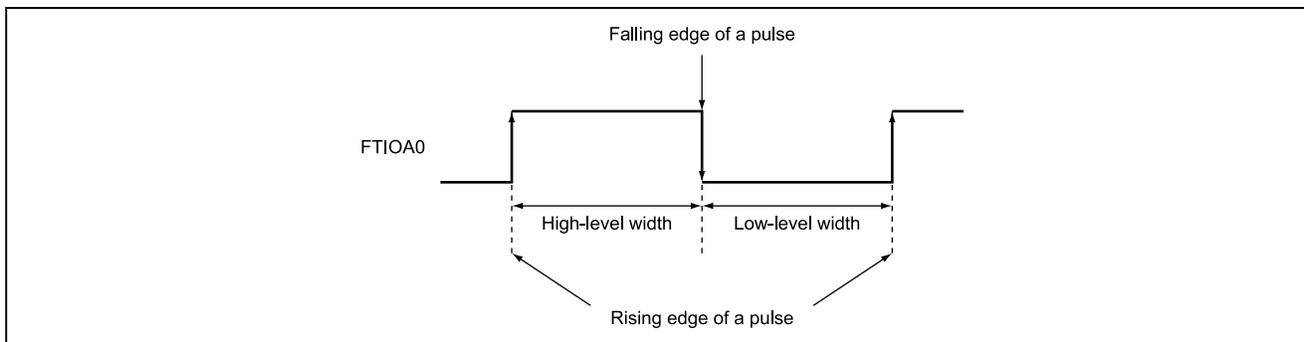


Figure 1.1 Measurement of Input Pulse Width

2. Description of Functions

1. In this sample task, the high-level width and low-level width of the pulse input to the input-capture input pin A0 (FTIOA0) is measured by using the buffer operation of timer Z input-capture function.

Figure 2.1 is a block diagram of timer Z input-capture function. The elements of the block diagram are described below.

- The system clock (ϕ) is a 16-MHz clock that is used as a reference clock for operating the CPU and peripheral functions.
- Prescaler S (PSS) is a 13-bit counter with clock input of ϕ . PSS is incremented every cycle.
- Timer control register 0 (TCR0) selects input clock and TCNT0 clearing method. In this sample task, the input clock is specified as $\phi/8$, the TCNT0 counts at the rising edge of $\phi/8$, and the TCNT0 is specified to be cleared on compare-match/input-capture with GRA0.
- Timer I/O control register A0 (TIORA0) controls GRA0 and GRB0. In this sample task, GRA0 is used as an input-capture register, and the TCNT0 value is transferred to the GRA0 at the rising and falling edges of the FTIOA0 pin.
- Timer I/O control register C0 (TIORC0) controls the GRC0 and GRD0. In this sample task, the GRC0 is specified as an input-capture register.
- Timer status register 0 (TSR0) indicates the timer Z status. In this sample task, the overflow flag (OVF) is set to 1 when TCNT0 overflows and the input capture/compare-match flag A (IMFA) are set to one when a GRA0 input capture occurs.
- Timer interrupt enable register (TIER0) enables or disables various interrupt requests. In this sample task, interrupts by the TSR0 OVF and IMFA flag are enabled and other interrupts are disabled.
- Timer counter 0 (TCNT0) is a 16-bit readable/writable upward counter that is incremented by the internal clock or external clock input. In this sample task, TCNT0 is incremented at the rising edge of $\phi/8$.
- General register A0 (GRA0) is a 16-bit readable/writable register. In this sample task, GRA0 functions as an input-capture register. The TCNT0 value is transferred to the GRA0 at the rising and falling edges of the FTIOA0 pin.
- General register C0 (GRC0) is a 16-bit readable/writable register. In this sample task, GRC0 functions as a buffer register for GRA0. The content of the GRA0 is transferred to the GRC0 at the rising and falling edges of the FTIOA0 pin.

- Timer start register (TSTR) starts or stops the TCNT0 and TCNT1 operation. In this sample task, TCNT0 is specified to start counting and TCNT1 to stop counting.
- Timer mode register (TMDR) selects synchronous or independent operation. In this sample task, GRA0 operates synchronous of GRC0. In this sample task, TCNT0 operates independently of TCNT1.
- Timer function control register (TFCR) specifies operation modes and selects the output level. In this sample task, channels 0 and 1 are specified for normal operation.
- Input-capture/output-compare pin A0 (FTIOA0) is specified as an input-capture input pin and the TCNT0 value is transferred to the GRA0 at the rising edge and falling edge of this pin.

Input pulse's width

= (TCNT0 value stored in plhigh or pllow) × (TCN0T input clock cycle)

= (TCNT0 value stored in plhigh or pllow) × (1/ (φ/PSS))

= (TCNT0 value stored in plhigh or pllow) × (1/ (16 MHz/8))

= (TCNT0 value stored in plhigh or pllow) × 0.5 μs

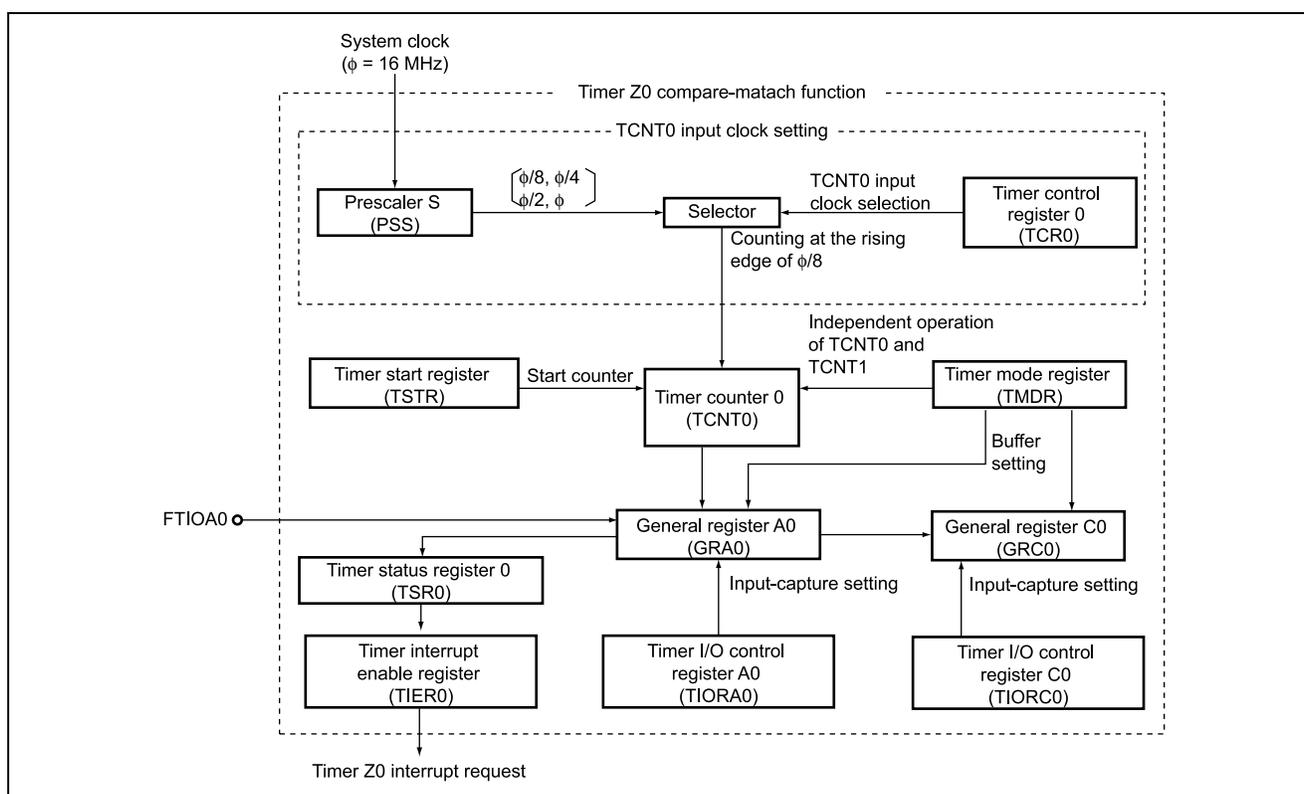


Figure 2.1 Timer Z0 Block Diagram

2. Table 2.1 lists the function allocation for this sample task. The functions listed in this table are allocated so that the high-level and low-level widths of the pulse can be measured.

Table 2.1 Function Allocation

Function	Description
PSS	13-bit counter with system clock input
TCR0	Specifies the TCNT0 clearing method and input clock.
TIORA0	Specifies the GRA0 as an input-capture register.
TIORC0	Specifies the GRC0 as an input-capture register.
TCNT0	16-bit upward counter that is incremented at the rising edge of $\phi/8$.
TSR0	Performs flag control for TNCT0 overflow and GRA0 input capture.
TIER0	Enables TCNT0 overflow and GRA0 input-capture interrupt requests..
GRA0	The TCNT0 value is transferred to the GRA0 at the rising and falling edges of the FTIOA0 pin.
GRC0	The GRA0 value is transferred to the GRC0 at the rising and falling edges of the FTIOA0 pin.
TSTR	Controls TCNT0 count start.
TMDR	Sets the GRA0 and GRC0 for buffer operation and selects independent operation of TCNT0 and TCNT1.
TFCR	Specifies channels 0 and 1 for normal operation.
FTIOA0 pin	Pulse input pin

3. Description of Operation

Figure 3.1 illustrates the operation of this sample task. The hardware and software processing are applied as shown in figure 3.1 to measure the high-level and low-level widths of the input pulse.

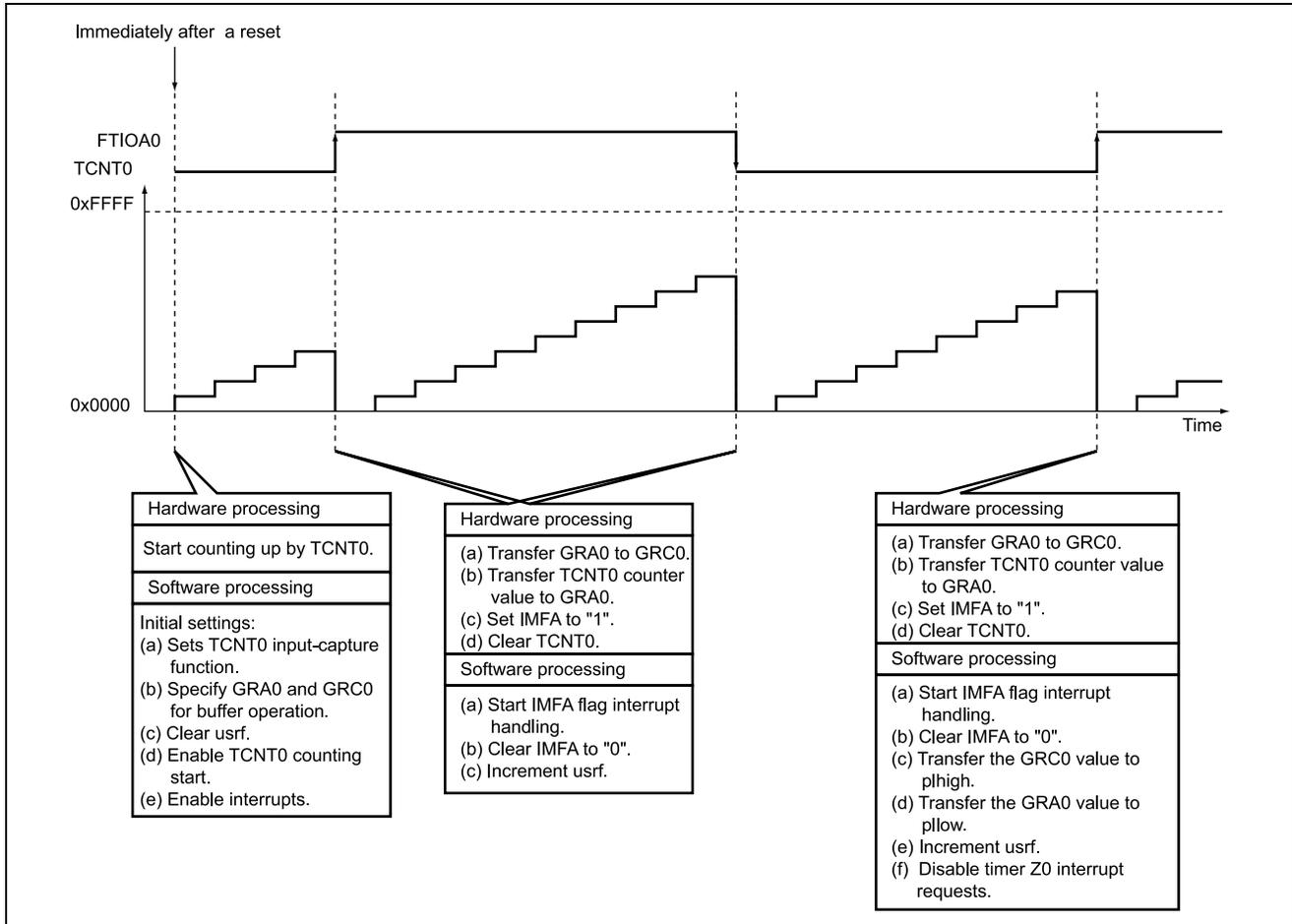


Figure 3.1 Principle of Operation

4. Description of Software

4.1 Modules

Table 4.1 describes the modules used in this sample task.

Table 4.1 Description of Modules

Module Name	Label Name	Function
Main routine	main	Sets timer Z0 input-capture function and buffer operation, starts counter operation, and specifies interrupts.
Pulse measurement end tz0int		Timer Z0 interrupt handling Clears OVF and IMFA flags, and stores high-level and low-level widths of the pulse in RAM.

4.2 Arguments

This sample task uses no arguments.

4.3 Internal Registers

The internal registers used in this sample task are described below.

- TCR0 Timer control register 0 Address: 0xF700

Bit	Bit Name	Setting	Function
7	CCLR2	CCLR2 = 0	Counter clear 2 to 0
6	CCLR1	CCLR1 = 0	CCLR2 = 0, CCLR1 = 0, CCLR0 = 1:
5	CCLR0	CCLR0 = 1	Clears TCNT0 on compare-match/input-capture with GRA0.
4	CKEG1	CKEG1 = 0	Clock edge 1 to 0
3	CKEG0	CKEG0 = 0	CKEG1 = 0, CKEG0 = 0: Counts at the rising edge of the clock.
2	TPSC2	TPSC2 = 0	Timer prescaler 2 to 0
1	TPSC1	TPSC1 = 1	TPSC2 = 0, TPSC1 = 1, TPSC0 = 1: Counts by $\phi/8$.
0	TPSC0	TPSC0 = 1	

- TIORA0 Timer I/O control register A0 Address: 0xF701

Bit	Bit Name	Setting	Function
2	IOA2	IOA2 = 1	I/O control A2 to A0
1	IOA1	IOA1 = 1	IOA2 = 1, IOA1 = 1, IOA0 = X:
0	IOA0	IOA0 = 0	The GRA0 is used as an input-capture register and the TCNT0 value is transferred to the GRA0 at the rising and falling edges of the FTIOA0 pin. (X: don't care)

- TIORC0 Timer I/O control register C0 Address: 0xF702

Bit	Bit Name	Setting	Function
2	IOC2	IOC2 = 1	I/O control C2 to C0
1	IOC1	IOC1 = 1	IOC2 = 1, IOC1 = 1, IOC0 = X:
0	IOC0	IOC0 = 0	The GRC0 is used as an input-capture register and the GRA0 value is transferred to the GRC0 at the rising and falling edges of the FTIOA0 pin. (X: don't care)

- **TSR0** Timer status register 0 Address: 0xF703

Bit	Bit Name	Setting	Function
4	OVF	0	Timer overflow: OVF = 0: Indicates that TCNT0 overflow has not occurred. OVF = 1: Indicates that TCNT0 overflow has occurred.
0	IMFA	1	Input-capture/compare-match flag A: When the GRA0 functions as an input-capture register, IMFA indicates that the TCNT0 value has been transferred to the GRA0 based on an input-capture signal. IMFA = 0: Indicates that the TCNT0 value has not been transferred to GRA0. IMFA = 1: Indicates that the TCNT0 value has been transferred to GRA0.

- **TIER0** Timer interrupt enable register 0 Address: 0xF704

Bit	Bit Name	Setting	Function
4	OVIE	1	Timer overflow interrupt enable: OVIE = 0: Disables interrupt requests by the OVF or UDF flag of TSR0. OVIE = 1: Enables an interrupt requested by the OVF or UDF flag of TSR0.
0	IMIEA	1	Input-capture/compare-match interrupt A enable: IMIEA = 0: Disables interrupt requests by the IMFA flag of TSR0. IMIEA = 1: Enables interrupt requests by the IMFA flag of TSR0.

- **TCNT0** Timer counter 0 Address: 0xF706
Function: A 16-bit upward counter that is incremented at the rising edge of $\phi/8$.
Setting: 0x0000

- **GRA0** General register A0 Address: 0xF708
Function: During input capture operation, the TCNT0 value is transferred to this register at the rising and falling edges of the FTIOA0 pin.
Setting: —

- **GRC0** General register C0 Address: 0xF70C
Function: When the GRC0 functions as the buffer register for the GRA0 in input capture operation, the GRA0 value is transferred to the GRC0 at the rising and falling edges of the FTIOA0 pin.
Setting: —

- **TSTR** Timer start register Address: 0xF720

Bit	Bit Name	Setting	Function
0	STR0	0	Channel 0 counter start STR0 = 0: Stops counting by TCNT0. STR0 = 1: Starts counting by TCNT0.

- **TMDR** Timer mode register Address: 0xF721

Bit	Bit Name	Setting	Function
4	BFC0	1	Buffer operation C BFC0 = 0: Specifies GRC0 for normal operation. BFC0 = 1: Specifies GRA0 and GRC0 for buffer operation.
0	SYNC	0	Timer synchronization SYNC = 0: TCNT0 operates independently of TCNT1. SYNC = 1: TCNT0 operates synchronously with TCNT1.

- TFCR Timer function control register Address: 0xF723

Bit	Bit Name	Setting	Function
1	CMD1	CMD1 = 0	Combination mode 1 to 0
0	CMD0	CMD0 = 0	CMD1 = 0, CMD0 = 0: Specifies channels 0 and 1 for normal operation.

4.4 Description of RAM

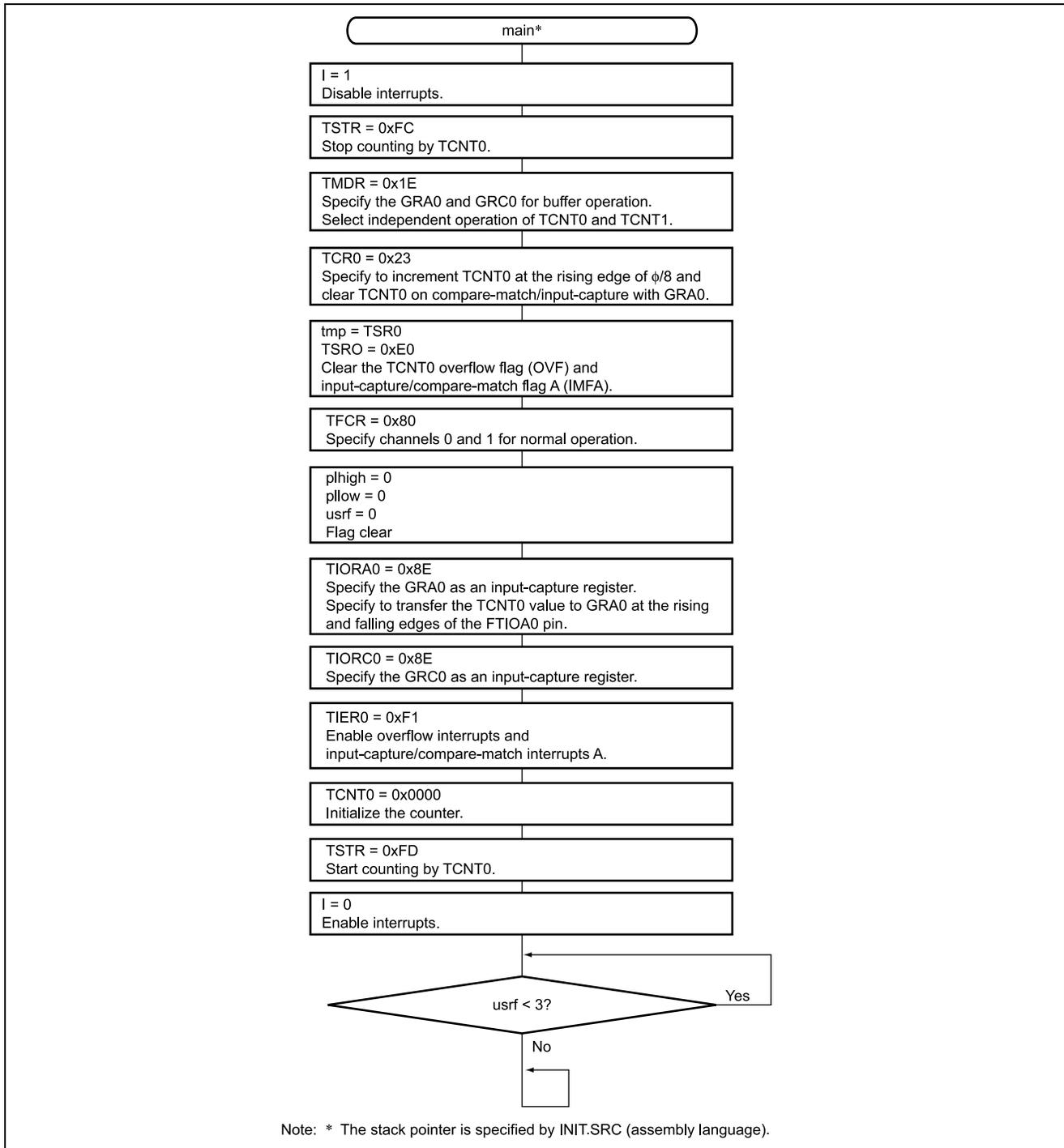
Table 4.2 describes the RAM usage in this sample task.

Table 4.2 Description of RAM

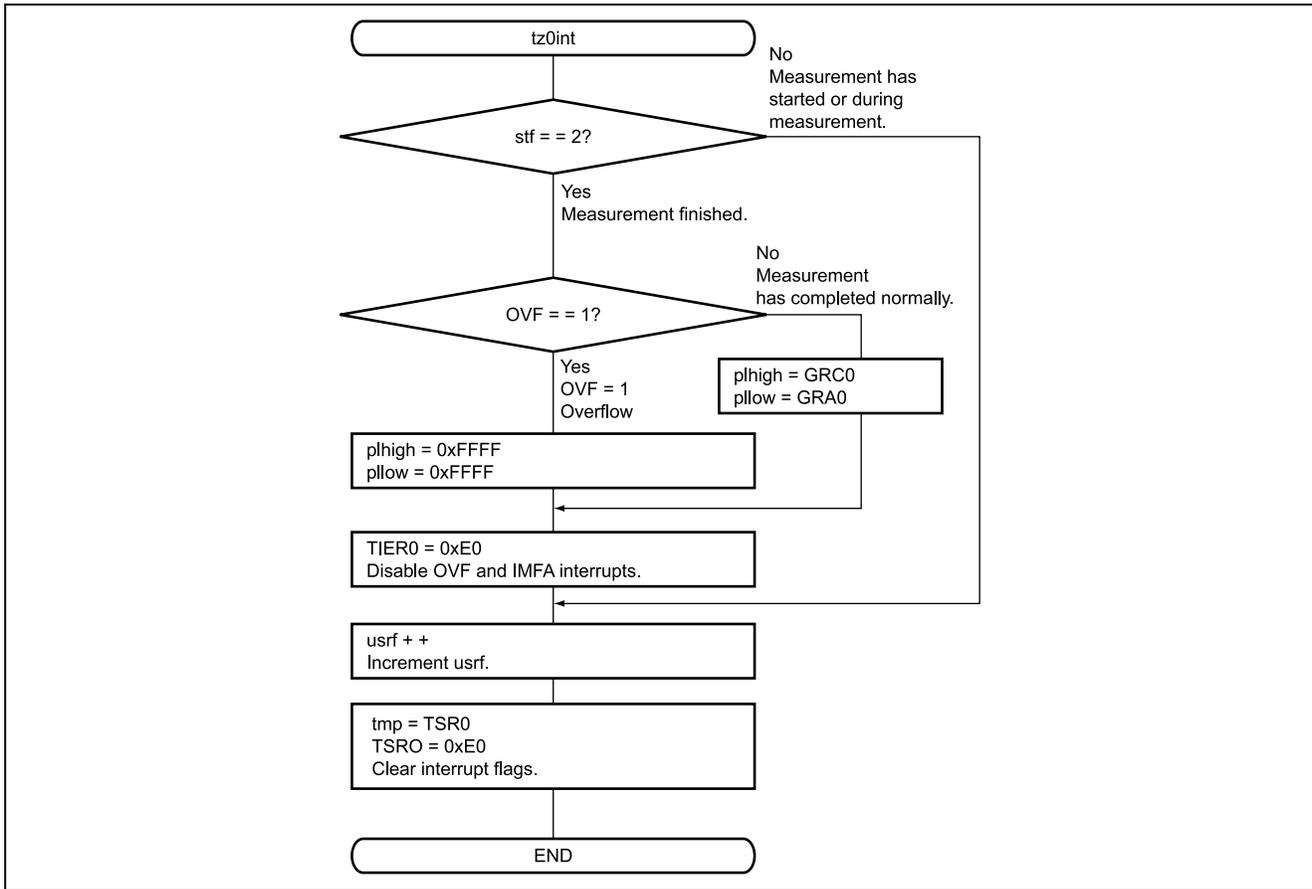
Label Name	Function	Size	Used in
plhigh	Pulse high-level width measurement result	2 bytes	Main routine Pulse width measurement end
pllow	Pulse low-level width measurement result	2 bytes	Main routine Pulse width measurement end
usfr	Timer Z interrupt status indicator usfr = 0: No interrupt has occurred. usfr = 1: Pulse width measurement has started. usfr = 2: Pulse high-level width measurement has completed. usfr = 3: Pulse low-level width measurement has completed/ Pulse width measurement has completed normally.	1 byte	Main routine Pulse width measurement end

5. Flowcharts

1. Main routine



2. Pulse width measurement end



6. Program Listing

```

/*****
/*
/* H8/300HN Series -H8/3687-
/* Application Note
/*
/* 'Pulse Period Measurement by Input Caputpre Function'
/*
/* Function
/* : Timer Z Input Caputpre
/*
/* External Clock : 16MHz
/* Internal Clock : 16MHz
/* Sub Clock : 32.768kHz
/*
*****/

#include <machine.h>

/*****
/* Symbol Definition
*****/

struct BIT {
    unsigned char b7:1; /* bit7 */
    unsigned char b6:1; /* bit6 */
    unsigned char b5:1; /* bit5 */
    unsigned char b4:1; /* bit4 */
    unsigned char b3:1; /* bit3 */
    unsigned char b2:1; /* bit2 */
    unsigned char b1:1; /* bit1 */
    unsigned char b0:1; /* bit0 */
};

#define TCR0 *(volatile unsigned char *)0xF700 /* Timer control register_0 */
#define TIORA0 *(volatile unsigned char *)0xF701 /* Timer I/O Control Register A_0 */
#define TIORC0 *(volatile unsigned char *)0xF702 /* Timer I/O Control Register C_0 */
#define TSR0 *(volatile unsigned char *)0xF703 /* Timer status register_0 */
#define TSR0_BIT (*(struct BIT *)0xF703) /* Timer status register_0 */
#define OVF TSR0_BIT.b4 /* Over flow flag */
#define IMFA TSR0_BIT.b0 /* Input Capture/Compare Match FlagA */
#define TIER0 *(volatile unsigned char *)0xF704 /* Timer interrupt enable register0 */
#define TIER0_BIT (*(struct BIT *)0xF704) /* Timer interrupt enable register0 */
#define IMIEA TIER0_BIT.b0 /* Input Capture/Compare Match */
/* Interrupt Enable A */

#define TCNT0 *(volatile unsigned short *)0xF706 /* Timer counter_0 */
#define GRA0 *(volatile unsigned short *)0xF708 /* General register A_0 */
#define GRC0 *(volatile unsigned short *)0xF70C /* General register C_0 */
#define TSTR *(volatile unsigned char *)0xF720 /* Timer start register */
#define TMDR *(volatile unsigned char *)0xF721 /* Timer mode register */
#define TPMP *(volatile unsigned char *)0xF722 /* Timer PWM mode register */
#define TFCR *(volatile unsigned char *)0xF723 /* Timer function control register */
#define TOER *(volatile unsigned char *)0xF724 /* Timer output master enable register */
#define TOCR *(volatile unsigned char *)0xF725 /* Timer output control register */

#pragma interrupt (tz0int)

```

```

/*****
/*  Function define
/*****
extern void INIT ( void );          /* SP Set
void main ( void );
void tz0int ( void );

/*****
/*  RAM define
/*****
volatile unsigned short plhigh;    /* Pulse time data
volatile unsigned short pllow;    /* Pulse time data
volatile unsigned char usrf;      /* User flag

/*****
/*  Vector Address
/*****
#pragma section V1                /* VECTOR SECTOIN SET
void (*const VEC_TBL1[])(void) = {
    INIT                          /* 00 Reset
};
#pragma section V2                /* VECTOR SECTOIN SET
void (*const VEC_TBL2[])(void) = {
    tz0int                        /* 34 Timer Z0 Interrupt
};

#pragma section                  /* P
/*****
/*  Main Program
/*****
void main ( void )
{
    unsigned char tmp;

    set_imask_ccr(1);             /* Interrupt Disable
                                   /*
    TSTR = 0xFC;                 /* TCNT0 count stop
    TMDR = 0x1E;                 /* TCNT0,TCNT1 Single Mode
                                   /*
    TCR0 = 0x23;                 /* GRC0 is used buffer of GRA0
    tmp = TSR0;                  /* Rising edge, phi/2 Clock count
    TSR0 = 0xE0;                 /* Interrupt Flag Clear
    TFCR = 0x80;                 /* Channel 0,1 operate normally
    plhigh = 0;                  /* Ram clear
    pllow = 0;                   /* Ram clear
    usrf = 0;                    /* Flag clear

    TIORA0 = 0x8E;               /* Input capture to GRA0 at both
                                   /*
    TIORC0 = 0x8E;               /* rising and falling edges
    TIER0 = 0xF1;                /* Input capture to GRC0
    TCNT0 = 0x0000;              /* IMFA Interrupt Enable
    TSTR = 0xFD;                 /* Clear TCNT0
                                   /*
    TSTR = 0xFD;                 /* TCNT0 count start
                                   /*

    set_imask_ccr(0);           /* Interrupt Enable
                                   /*

    while(usrf < 3);

    while(1);
}

```

```

/*****
/*   Timer Z0 Interrupt
*****/
void tz0int ( void )
{
    unsigned char tmp;

    if(usrf == 2){
        if(OVF == 1){
            plhigh = 0xFFFF;          /* Overflow
            pllow = 0xFFFF;          */
        }
        else{
            plhigh = GRC0;            /* Ram copy to GRC0
            pllow = GRA0;            /* Ram copy to GRA0
        }
        TIER0 = 0xE0;                /* OVF,IMFA Interrupt Disable
    }

    usrf++;                          /* User flag increment
    tmp = TSR0;
    TSR0 = 0xE0;                      /* Interrupt Flag Clear
}

```

Link address specifications

Section Name	Address
CV1	0x0000
CV2	0x0034
P	0x0100
B	0xFB80

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.29.03	—	First edition issued

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